

30EPH06PbF

Hyperfast Rectifier

Features

- · Hyperfastfast Recovery Time
- Low Forward Voltage Drop
- · Low Leakage Current
- · 175°C Operating Junction Temperature
- Single Diode Device
- · Lead-Free ("PbF" suffix)

t_{rr} = 28ns typ. $I_{F(AV)}$ = 30Amp V_R = 600V

Description/Applications

State of the art Hyperfast recovery rectifiers designed with optimized performance of forward voltage drop, Hyperfast recover time, and soft recovery.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness and reliability characteristics.

These devices are intended for use in PFC Boost stage in the AC-DC section of SMPS, inverters or as freewheeling diodes.

The IR extremely optimized stored charge and low recovery current minimize the switching losses and reduce over dissipation in the switching element and snubbers.

Absolute Maximum Ratings

	Parameters		Max	Units
V _{RRM}	Peak Repetitive Reverse Voltage		600	V
I _{F(AV)}	Average Rectifier Forward Current	@ T _C = 116°C	30	А
I _{FSM}	Non Repetitive Peak Surge Current	@ T _J = 25°C	300	
T _J , T _{STG}	Operating Junction and Storage Tempe	- 65 to 175	°C	



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Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameters	Min	Тур	Max	Units	Test Conditions
V_{BR}, V_r	Breakdown Voltage, Blocking Voltage	600	-	-	V	I _R = 100μA
V _F	Forward Voltage	-	2.0	2.6	V	I _F = 30A, T _J = 25°C
		-	1.34	1.75	V	I _F = 30A, T _J = 150°C
I _R	Reverse Leakage Current	-	0.3	50	μA	V _R = V _R Rated
		-	60	500	μA	$T_J = 150$ °C, $V_R = V_R$ Rated
C _T	Junction Capacitance	-	33	-	pF	V _R = 600V
L _S	Series Inductance	-	3.5	-	nH	Measured lead to lead 5mm from package body

Dynamic Recovery Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameters	Min	Тур	Max	Units	Test Conditions			
t _{rr}	Reverse Recovery Time	-	28	35	ns	I _F = 1.0A, di _F /dt =	50A/μs, V _R = 30V		
		-	31	-		T _J = 25°C	I _F = 30A		
			77	-		T _J = 125°C	V _R = 200V		
I _{RRM}	Peak Recovery Current	-	3.5	-	Α	T _J = 25°C	di _F /dt = 200A/μs		
		-	7.7	-		T _J = 125°C			
Q _{rr}	Reverse Recovery Charge	-	65	-	nC	T _J = 25°C			
		-	345	-		T _J = 125°C			

Thermal - Mechanical Characteristics

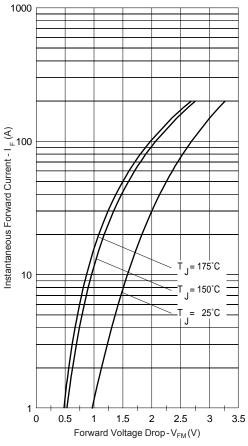
	Parameters		Min	Тур	Max	Units
TJ	Max. Junction Temperature Range		- 65	-	175	°C
T_{Stg}	Max. Storage Temperature Range		- 65	-	175	
R _{thJC}	Thermal Resistance, Junction to Case	Per Leg	-	0.5	0.9	°C/W
R_{thJA} ^①	Thermal Resistance, Junction to Ambient	Per Leg	-	-	70	
$R_{thCS}{}^{\textcircled{2}}$	Thermal Resistance, Case to Heatsink		-	0.4	-	
Wt	Weight		-	6.0	-	g
			-	0.22	-	(oz)
	Mounting Torque		6.0	-	12	Kg-cm
			5.0	-	10	lbf.in
	Case Style	TO-247AC				
	DeviceMarking	30EPH06				

① Typical Socket Mount

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② Mounting Surface, Flat, Smooth and Greased

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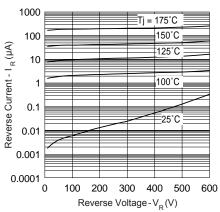


Fig. 2-Typical Values Of Reverse Current Vs. Reverse Voltage

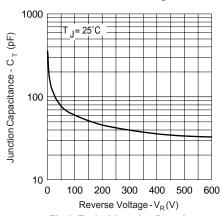
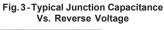


Fig. 1-Typical Forward Voltage Drop Characteristics



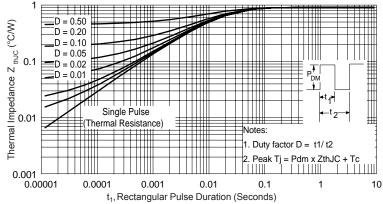


Fig. 4-Max. Thermal Impedance Z_{thJC} Characteristics

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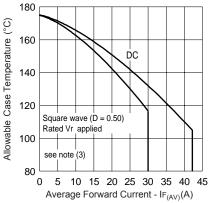


Fig. 5 - Max. Allowable Case Temperature Vs. Average Forward Current

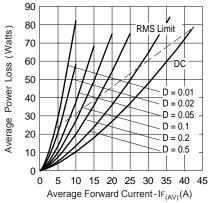


Fig. 6-Forward Power Loss Characteristics

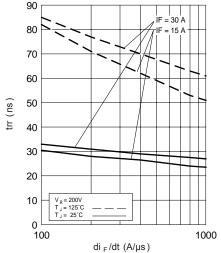


Fig. 7 - Typical Reverse Recovery vs. di _F/dt

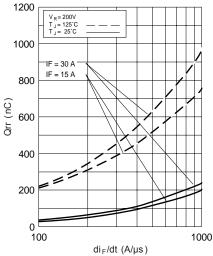
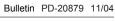


Fig. 8 - Typical Stored Charge vs. di_F/dt

 $\begin{aligned} \textbf{(3)} \ \ & \text{Formula used:} \ & T_{\text{C}} = T_{\text{J}} - (\text{Pd} + \text{Pd}_{\text{REV}}) \times R_{\text{thJC}}; \\ & \text{Pd} = \text{Forward PowerLoss} = I_{\text{F(AV)}} \times V_{\text{FM}} \textcircled{0} \ (I_{\text{F(AV)}} / D) \ \ (\text{see Fig. 6}); \\ & \text{Pd}_{\text{REV}} = \text{Inverse PowerLoss} = V_{\text{R1}} \times I_{\text{R}} (1 - D); \ I_{\text{R}} \textcircled{0} V_{\text{R1}} = \text{rated} V_{\text{R}} \end{aligned}$

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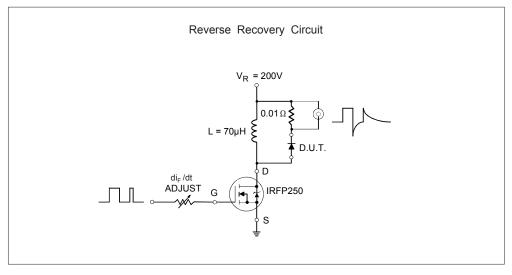


Fig. 9- Reverse Recovery Parameter Test Circuit

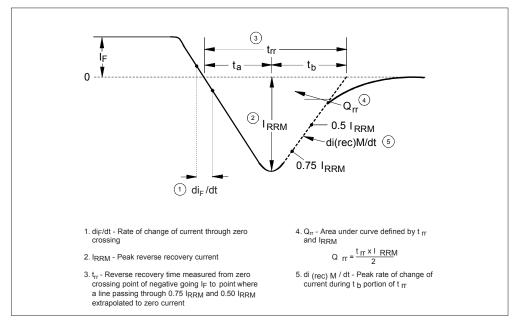
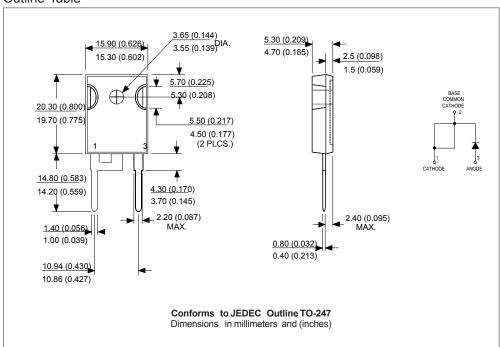


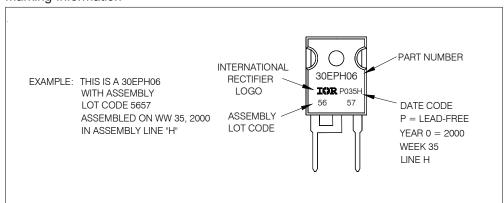
Fig. 10 - Reverse Recovery Waveform and Definitions

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Outline Table



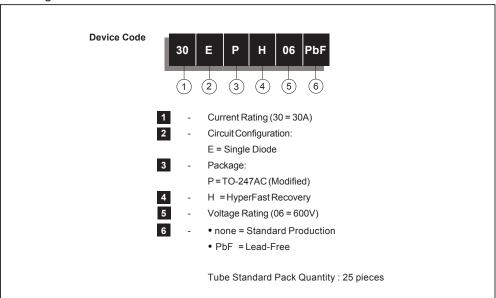
Marking Information



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Ordering Information Table



Data and specifications subject to change without notice. This product has been designed and qualified for Industrial Level and Lead-Free.

Qualification Standards can be found on IR's Web site.



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